Lattice Semiconductor Corporation - LFE2-12E-6T144I Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

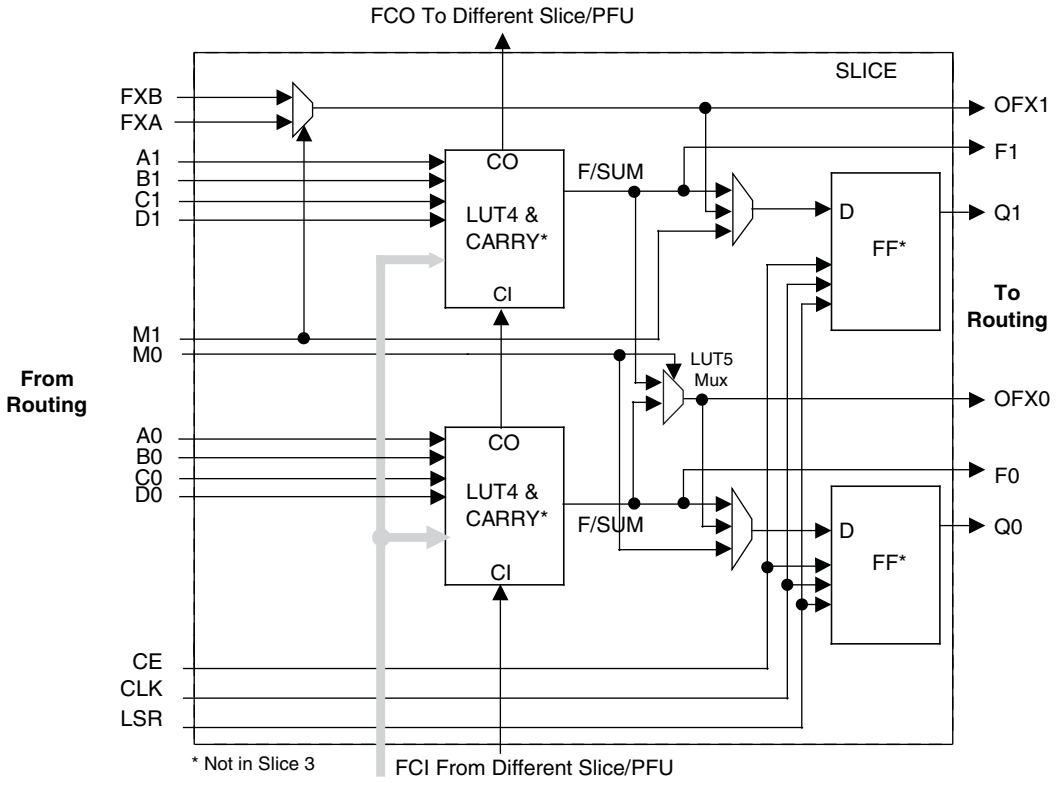
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	93
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12e-6t144i

Figure 2-4. Slice Diagram



For Slices 0 and 2, memory control signals are generated from Slice 1 as follows:

WCK is CLK
WRE is from LSR
DI[3:2] for Slice 2 and DI[1:0] for Slice 0 data
WAD [A:D] is a 4bit address from slice 1 LUT input

Table 2-2. Slice Signal Descriptions

Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FC	Fast Carry-in[1]
Input	Inter-slice signal	FXA	Intermediate signal to generate LUT6 and LUT7
Input	Inter-slice signal	FXB	Intermediate signal to generate LUT6 and LUT7
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8[2] MUX depending on the slice
Output	Inter-PFU signal	FCO	Slice 2 of each PFU is the fast carry chain output[1]

1. See Figure 2-4 for connection details.
2. Requires two PFUs.

ROM Mode
ROM mode uses the LUT logic; hence, Slices 0 through 3 can be used in ROM mode. Preloading is accomplished through the programming interface during PFU configuration.

Routing

There are many resources provided in the LatticeECP2/M devices to route signals individually or as buses with related control signals. The routing resources consist of switching circuitry, buffers and metal interconnect (routing) segments.

The inter-PFU connections are made with x1 (spans two PFU), x2 (spans three PFU) and x6 (spans seven PFU). The x1 and x2 connections provide fast and efficient connections in horizontal and vertical directions. The x2 and x6 resources are buffered, allowing the routing of both short and long connections between PFUs.

The LatticeECP2/M family has an enhanced routing architecture that produces a compact design. The Diamond design software takes the output of the synthesis tool and places and routes the design. Generally, the place and route tool is completely automatic, although an interactive routing editor is available to optimize the design.

sysCLOCK Phase Locked Loops (GPLL/SPLL)

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. All the devices in the LatticeECP2/M family support two General Purpose PLLs (GPLLs) which are full-featured PLLs. In addition, some of the larger devices have two to six Standard PLLs (SPLLs) that have a subset of GPLL functionality.

General Purpose PLL (GPLL)

The architecture of the GPLL is shown in Figure 2-5. A description of the GPLL functionality follows.

CLKI is the reference frequency (generated either from the pin or from routing) for the PLL. CLKI feeds into the Input Clock Divider block. The CLKFB is the feedback signal (generated from CLKOP or from a user clock PIN/logic). This signal feeds into the Feedback Divider. The Feedback Divider is used to multiply the reference frequency.

The Delay Adjust Block adjusts either the delays of the reference or feedback signals. The Delay Adjust Block can either be programmed during configuration or can be adjusted dynamically. The setup, hold or clock-to-out times of the device can be improved by programming a delay in the feedback or input path of the PLL, which will advance or delay the output clock with reference to the input clock.

Following the Delay Adjust Block, both the input path and feedback signals enter the Voltage Controlled Oscillator (VCO) block. In this block the difference between the input path and feedback signals is used to control the frequency and phase of the oscillator. A LOCK signal is generated by the VCO to indicate that the VCO has locked onto the input clock signal. In dynamic mode, the PLL may lose lock after a dynamic delay adjustment and not relock until the t_{LOCK} parameter has been satisfied. LatticeECP2/M devices have two dedicated pins on the left and right edges of the device for connecting optional external capacitors to the VCO. This allows the PLLs to operate at a lower frequency. This is a shared resource that can only be used by one PLL (GPLL or SPLL) per side.

The output of the VCO then enters the post-scalar divider. The post-scalar divider allows the VCO to operate at higher frequencies than the clock output (CLKOP), thereby increasing the frequency range. A secondary divider takes the CLKOP signal and uses it to derive lower frequency outputs (CLKOK). The Phase/Duty Select block adjusts the phase and duty cycle of the CLKOP signal and generates the CLKOS signal. The phase/duty cycle setting can be pre-programmed or dynamically adjusted.

The primary output from the post scalar divider CLKOP along with the outputs from the secondary divider (CLKOK) and Phase/Duty select (CLKOS) are fed to the clock distribution network.

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

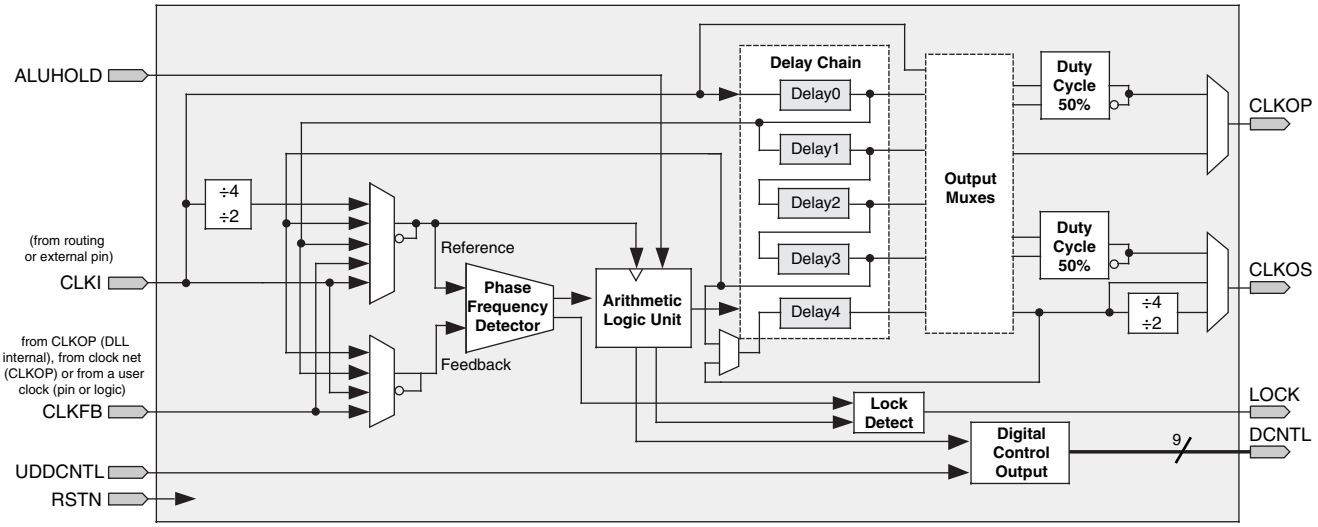
CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

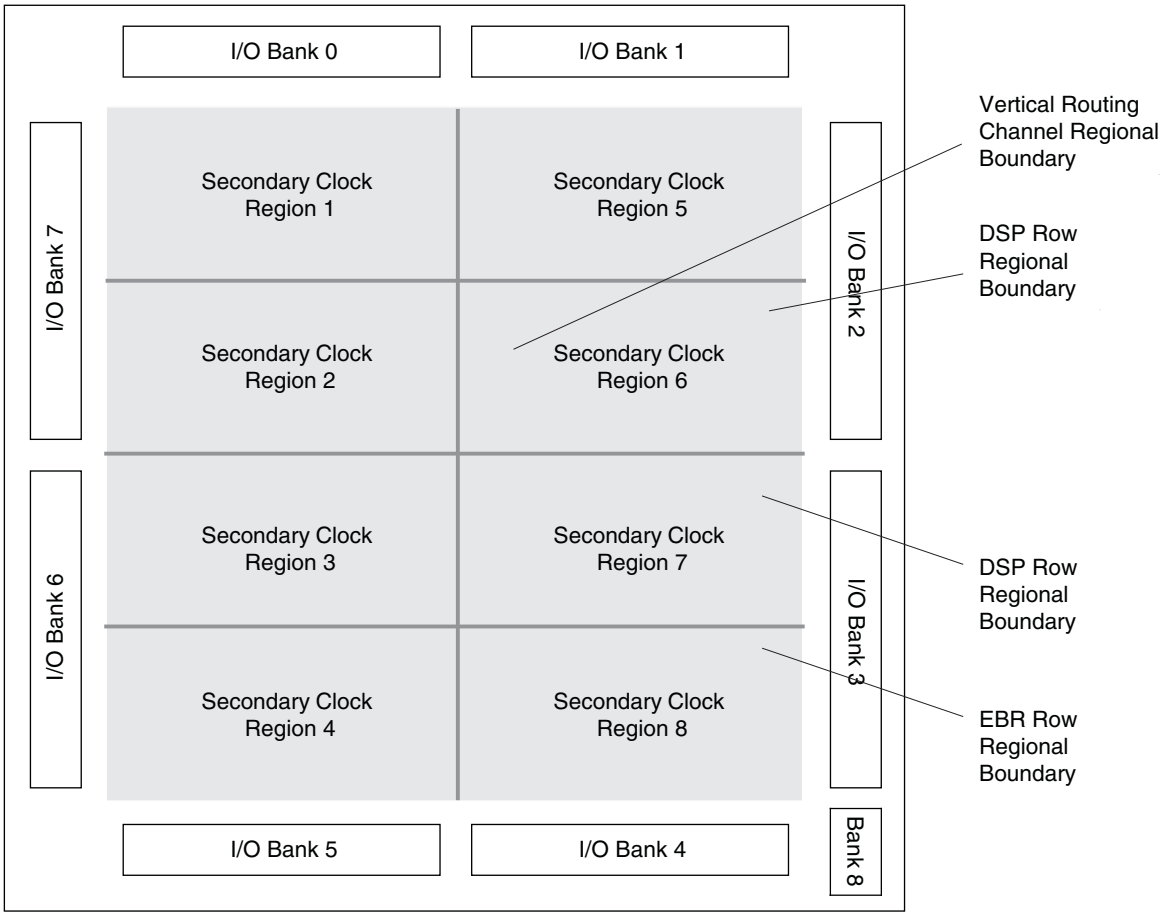
Figure 2-6. Delay Locked Loop Diagram (DLL)



this special vertical routing channel and the eight secondary clock regions for the ECP2-50. LatticeECP2 devices have four secondary clocks (SC0 to SC3) which are distrubed to every region.

The secondary clock muxes are located in the center of the device. Figure 2-16 shows the mux structure of the secondary clock routing. Secondary clocks SC0 to SC3 are used for clock and control and SC4 to SC7 are used for high fan-out signals.

Figure 2-15. Secondary Clock Regions ECP2-50



for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm ±1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5[1]	13.0	45.0	2.5[1]
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

LatticeECP2/M External Switching Characteristics[9] (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{DIBSPI}	Data Invalid Before Clock (Transmit)	ECP2-20	—	280	—	280	—	280	ps
		ECP2-35	—	280	—	280	—	280	ps
		ECP2-50	—	280	—	280	—	280	ps
		ECP2-70	—	280	—	280	—	280	ps
		ECP2M20	—	230	—	230	—	230	ps
		ECP2M35	—	230	—	230	—	230	ps
		ECP2M50	—	230	—	230	—	230	ps
		ECP2M70	—	230	—	230	—	230	ps
		ECP2M100	—	230	—	230	—	230	ps
XGMII I/O Pin Parameters (312 Mbps)[5]									
$t_{SUXGMII}$	Data Setup Before Read Clock	ECP2/M	480	—	480	—	480	—	ps
t_{HXGMII}	Data Hold After Read Clock	ECP2/M	480	—	480	—	480	—	ps
$t_{DVBCKXGMII}$	Data Valid Before Clock	ECP2/M	960	—	960	—	960	—	ps
$t_{DVACKXGMII}$	Data Valid After Clock	ECP2/M	960	—	960	—	960	—	ps
Primary									
f_{MAX_PRI}[7]	Frequency for Primary Clock Tree	ECP2/M	—	420	—	357	—	311	MHz
t_{W_PRI}	Clock Pulse Width for Primary Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t_{SKEW_PRI}	Primary Clock Skew Within a Bank	ECP2/M	—	300	—	360	—	420	ps
Edge Clock									
f_{MAX_EDGE}[7]	Frequency for Edge Clock	ECP2/M	—	420	—	357	—	311	MHz
t_{W_EDGE}	Clock Pulse Width for Edge Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t_{SKEW_EDGE}	Edge Clock Skew Within an Edge of the Device	ECP2/M	—	300	—	360	—	420	ps

1. General timing numbers based on LVCMOS 2.5, 12mA, 0pf load.
2. DDR timing numbers based on SSTL25 for BGA packages only.
3. DDR2 timing numbers based on SSTL18 for BGA packages only.
4. SPI4.2 and SFI4 timing numbers based on LVDS25 for BGA packages only.
5. XGMII timing numbers based on HSTL class I. A corresponding left/right dedicated clock buffer is used when using the SPI4.2 interface to the left or right edge of the device. For SPI4.2 mode, the software tool will help in selecting the appropriate clock buffer.
6. IP will be used to support DDR and DDR2 memory data rates down to 95MHz. This approach uses a free-running clock and PFU register to sample the data instead of the hardwired DDR memory interface.
7. Using the LVDS I/O standard.
8. ECP2-6 and ECP2-12 do not support SPI4.2
9. The AC numbers do not apply to PCLK6 and PCLK7.
10. Applies to CLKOP only.
11. Please refer to TN1159, LatticeECP2/M Pin Assignment Recommendations for best performance.

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P5	P5	VCCIO5	5		
K5	K5	VCCIO6	6		
M3	M3	VCCIO6	6		
E3	E3	VCCIO7	7		
G5	G5	VCCIO7	7		
T15	T15	VCCIO8	8		
A1	A1	GND	-		
A16	A16	GND	-		
B12	B12	GND	-		
B5	B5	GND	-		
C8	C8	GND	-		
E15	E15	GND	-		
E2	E2	GND	-		
H14	H14	GND	-		
H8	H8	GND	-		
H9	H9	GND	-		
J3	J3	GND	-		
J8	J8	GND	-		
J9	J9	GND	-		
M15	M15	GND	-		
M2	M2	GND	-		
P9	P9	GND	-		
R12	R12	GND	-		
R5	R5	GND	-		
T1	T1	GND	-		
T16	T16	GND	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D25	PT99A	1		T
J22	PT98B	1		C
J21	PT98A	1		T
VCCIO	VCCIO1	1		
B25	PT97B	1		C
A25	PT97A	1		T
E24	PT96B	1		C
F24	PT96A	1		T
GND	GNDIO1	-		
F23	PT95B	1		C
H22	PT95A	1		T
D24	PT94B	1		C
C24	PT94A	1		T
VCCIO	VCCIO1	1		
E23	PT93B	1		C
G23	PT93A	1		T
B24	PT92B	1		C
A24	PT92A	1		T
C27	PT91B	1		C
GND	GNDIO1	-		
D27	PT91A	1		T
C26	PT90B	1		C
D26	PT90A	1		T
A27	PT89B	1		C
VCCIO	VCCIO1	1		
B27	PT89A	1		T
A28	PT88B	1		C
B28	PT88A	1		T
A29	PT87B	1		C
B29	PT87A	1		T
GND	GNDIO1	-		
VCCIO	VCCIO1	1		
H21	PT80B	1		C
F22	PT80A	1		T
VCCIO	VCCIO1	1		
B23	PT79B	1		C
A23	PT79A	1		T
G24	PT78B	1		C
E22	PT78A	1		T
GND	GNDIO1	-		
D22	PT77B	1		C
C22	PT77A	1		T
G22	PT76B	1		C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AG4	NC	-		
AG8	NC	-		
AH1	NC	-		
AH16	NC	-		
AH2	NC	-		
AH26	NC	-		
AH27	NC	-		
AH29	NC	-		
AH30	NC	-		
AH4	NC	-		
AJ1	NC	-		
AJ2	NC	-		
AJ27	NC	-		
AJ28	NC	-		
AJ29	NC	-		
AJ3	NC	-		
AJ30	NC	-		
AK2	NC	-		
AK27	NC	-		
AK28	NC	-		
AK29	NC	-		
AK3	NC	-		
B1	NC	-		
B2	NC	-		
B3	NC	-		
B30	NC	-		
B4	NC	-		
B5	NC	-		
C1	NC	-		
C2	NC	-		
C29	NC	-		
C30	NC	-		
C4	NC	-		
D13	NC	-		
D18	NC	-		
D23	NC	-		
D28	NC	-		
D29	NC	-		
D3	NC	-		
D30	NC	-		
D4	NC	-		
E25	NC	-		
E26	NC	-		

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E13	PT28B	1		C	PT46B	1		C
D12	PT28A	1		T	PT46A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
A9	PT27B	1		C	PT45B	1		C
A8	PT27A	1		T	PT45A	1		T
A7	PT26B	1		C	PT44B	1		C
A6	PT26A	1		T	PT44A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
E12	PT25B	1		C	PT43B	1		C
F12	PT25A	1		T	PT43A	1		T
A5	PT24B	1		C	PT42B	1		C
A4	PT24A	1		T	PT42A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
B7	PT23B	1		C	PT41B	1		C
B8	PT23A	1		T	PT41A	1		T
G11	PT22B	1		C	PT40B	1		C
E11	PT22A	1		T	PT40A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
D11	PT21B	1	VREF2_1	C	PT39B	1	VREF2_1	C
D10	PT21A	1	VREF1_1	T	PT39A	1	VREF1_1	T
F11	PT20A	1	PCLKT1_0	T	PT38A	1	PCLKT1_0	T
G10	PT20B	1	PCLKC1_0	C	PT38B	1	PCLKC1_0	C
G9	PT19B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C
GNDIO	GNDIO0	-			GNDIO0	-		
F9	PT19A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T
C9	PT18B	0	VREF2_0	C	PT36B	0	VREF2_0	C
D9	PT18A	0	VREF1_0	T	PT36A	0	VREF1_0	T
A2	PT17B	0		C	PT35B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
A3	PT17A	0		T	PT35A	0		T
B3	PT16B	0		C	PT34B	0		C
C4	PT16A	0		T	PT34A	0		T
E10	PT15B	0		C	PT33B	0		C
F10	PT15A	0		T	PT33A	0		T
C7	PT14B	0		C	PT32B	0		C
GNDIO	GNDIO0	-			GNDIO0	-		
B6	PT14A	0		T	PT32A	0		T
C6	PT13B	0		C	PT31B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
C5	PT13A	0		T	PT31A	0		T
C8	PT12B	0		C	PT30B	0		C
D8	PT12A	0		T	PT30A	0		T
E8	PT11B	0		C	PT29B	0		C
E9	PT11A	0		T	PT29A	0		T
-	-	-			GNDIO0	-		
-	-	-			VCCIO0	0		
F8	PT10B	0		C	PT10B	0		C
G8	PT10A	0		T	PT10A	0		T

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
M19	PR50A	3	RDQ52	T (LVDS)*
M18	PR49B	3	RDQ52	C
VCCIO	VCCIO3	3		
L16	PR49A	3	RDQ52	T
L22	PR48B	3	RDQ52	C (LVDS)*
L21	PR48A	3	RDQ52	T (LVDS)*
GNDIO	GNDIO3	-		
K22	PR46B	3	RLM3_SPLLC_FB_A	C
VCCIO	VCCIO3	3		
K21	PR46A	3	RLM3_SPLLT_FB_A	T
L17	PR45B	3	RLM3_SPLLC_IN_A	C (LVDS)*
L18	PR45A	3	RLM3_SPLLT_IN_A	T (LVDS)*
GNDIO	GNDIO3	-		
L20	PR44B	3		C
L19	PR44A	3		T
K16	PR43B	3		C (LVDS)*
K17	PR43A	3		T (LVDS)*
VCCIO	VCCIO3	3		
J16	PR42B	3	VREF2_3	C
K18	PR42A	3	VREF1_3	T
J22	PR41B	3	PCLKC3_0	C (LVDS)*
J21	PR41A	3	PCLKT3_0	T (LVDS)*
H22	PR39B	2	PCLKC2_0/RDQ36	C
H21	PR39A	2	PCLKT2_0/RDQ36	T
GNDIO	GNDIO2	-		
J17	PR38B	2	RDQ36	C (LVDS)*
J18	PR38A	2	RDQ36	T (LVDS)*
J20	PR37B	2	RDQ36	C
J19	PR37A	2	RDQ36	T
VCCIO	VCCIO2	2		
H16	PR36B	2	RDQ36	C (LVDS)*
H17	PR36A	2	RDQS36	T (LVDS)*
G22	PR35B	2	RDQ36	C
GNDIO	GNDIO2	-		
G21	PR35A	2	RDQ36	T
H20	PR34B	2	RDQ36	C (LVDS)*
H19	PR34A	2	RDQ36	T (LVDS)*
G16	PR33B	2	RUM3_SPLLC_FB_A/RDQ36	C
VCCIO	VCCIO2	2		
H18	PR33A	2	RUM3_SPLLT_FB_A/RDQ36	T
F22	PR32B	2	RUM3_SPLLC_IN_A/RDQ36	C (LVDS)*
F21	PR32A	2	RUM3_SPLLT_IN_A/RDQ36	T (LVDS)*
G20	PR30B	2	RDQ27	C

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO3	3			VCCIO3	3		
U20	PR58A	3	RLM0_GPLLT_IN_A**/RDQ57	T	PR63A	3	RLM0_GPLLT_IN_A	T
W24	PR57B	3	RLM0_GPLLC_FB_A/RDQ57	C (LVDS)*	PR62B	3	RLM0_GPLLC_FB_A	C*
V24	PR57A	3	RLM0_GPLLT_FB_A/RDQS57	T (LVDS)*	PR62A	3	RLM0_GPLLT_FB_A	T*
GNDIO	GNDIO3	-			GNDIO3	-		
U21	PR56A	3	RDQ57	T	PR60A	3		T
W25	PR55B	3	RDQ57	C (LVDS)*	PR59B	3		C*
W26	PR55A	3	RDQ57	T (LVDS)*	PR59A	3		T*
VCCIO	VCCIO3	3			VCCIO3	3		
U18	PR54B	3	RDQ57	C	PR58B	3		C
U22	PR54A	3	RDQ57	T	PR58A	3		T
V25	PR53B	3	RDQ57	C (LVDS)*	PR57B	3		C*
V26	PR53A	3	RDQ57	T (LVDS)*	PR57A	3		T*
U24	PR51B	3	RDQ48	C	PR55B	3	RDQ52	C
T24	PR51A	3	RDQ48	T	PR55A	3	RDQ52	T
GNDIO	GNDIO3	-			GNDIO3	-		
T22	PR50B	3	RDQ48	C (LVDS)*	PR54B	3	RDQ52	C*
T23	PR50A	3	RDQ48	T (LVDS)*	PR54A	3	RDQ52	T*
U25	PR49B	3	RDQ48	C	PR53B	3	RDQ52	C
U26	PR49A	3	RDQ48	T	PR53A	3	RDQ52	T
VCCIO	VCCIO3	3			VCCIO3	3		
T19	PR48B	3	RDQ48	C (LVDS)*	PR52B	3	RDQ52	C*
R19	PR48A	3	RDQS48	T (LVDS)*	PR52A	3	RDQS52	T*
R21	PR47B	3	RDQ48	C	PR51B	3	RDQ52	C
GNDIO	GNDIO3	-			GNDIO3	-		
R20	PR47A	3	RDQ48	T	PR51A	3	RDQ52	T
T26	PR46B	3	RDQ48	C (LVDS)*	PR50B	3	RDQ52	C*
R26	PR46A	3	RDQ48	T (LVDS)*	PR50A	3	RDQ52	T*
P21	PR45B	3	RDQ48	C	PR49B	3	RDQ52	C
VCCIO	VCCIO3	3			VCCIO3	3		
P19	PR45A	3	RDQ48	T	PR49A	3	RDQ52	T
R23	PR44B	3	RDQ48	C (LVDS)*	PR48B	3	RDQ52	C*
R24	PR44A	3	RDQ48	T (LVDS)*	PR48A	3	RDQ52	T*
-	-	-			GNDIO3	-		
R22	PR42B	3	RLM2_SPLLC_FB_A	C	PR46B	3	RLM3_SPLLC_FB_A	C
VCCIO	VCCIO3	3			VCCIO3	3		
N19	PR42A	3	RLM2_SPLLT_FB_A	T	PR46A	3	RLM3_SPLLT_FB_A	T
P23	PR41B	3	RLM2_SPLLC_IN_A	C (LVDS)*	PR45B	3	RLM3_SPLLC_IN_A	C*
P24	PR41A	3	RLM2_SPLLT_IN_A	T (LVDS)*	PR45A	3	RLM3_SPLLT_IN_A	T*
GNDIO	GNDIO3	-			GNDIO3	-		
N21	PR40B	3		C	PR44B	3		C
P22	PR40A	3		T	PR44A	3		T
N20	PR39B	3		C (LVDS)*	PR43B	3		C*
N22	PR39A	3		T (LVDS)*	PR43A	3		T*
VCCIO	VCCIO3	3			VCCIO3	3		
P25	PR38B	3	VREF2_3	C	PR42B	3	VREF2_3	C
P26	PR38A	3	VREF1_3	T	PR42A	3	VREF1_3	T
M21	PR37B	3	PCLKC3_0	C (LVDS)*	PR41B	3	PCLKC3_0	C*

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K19	PR16A	2	RDQ15	T	PR19A	2		T
G24	PR15B	2	RDQ15	C (LVDS)*	PR18B	2		C*
G23	PR15A	2	RDQS15	T (LVDS)*	PR18A	2		T*
GNDIO	GNDIO2	-			GNDIO2	-		
J18	PR14B	2	RDQ15	C	PR14B	2		C
F22	PR14A	2	RDQ15	T	PR14A	2		T
-	-	-			VCCIO2	2		
F23	PR13B	2	RDQ15	C (LVDS)*	PR13B	2		C*
F24	PR13A	2	RDQ15	T (LVDS)*	PR13A	2		T*
VCCIO	VCCIO2	2			-	-		
H20	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C	PR12B	2	RUM0_SPLLC_FB_A	C
-	-	-			GNDIO2	-		
F21	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T	PR12A	2	RUM0_SPLLT_FB_A	T
G26	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A	C*
F26	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A	T*
-	-	-			VCCIO2	2		
E24	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
GNDIO	GNDIO2	-			GNDIO2	-		
E23	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO4	4			VCCIO2	2		
H19	XRES	-			XRES	-		
C25	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
A24	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B25	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
B24	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
C22	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A21	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
A22	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
B21	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
C21	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
B20	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
C20	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A20	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
C24	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
B23	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
C23	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
A23	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
B19	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
E19	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D19	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
C19	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
A15	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D2	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7	T
D3	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-			GNDIO7	-		
J8	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
H7	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
E3	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
E4	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
GNDIO	GNDIO7	-			-	-		
G6	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*
F5	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*
E2	PL14A	7		T	PL14A	7	LDQ15	T
D1	PL14B	7		C	PL14B	7	LDQ15	C
-	-	-			GNDIO7	-		
G5	NC	-			PL15A	7	LDQS15	T (LVDS)*
G4	NC	-			PL15B	7	LDQ15	C (LVDS)*
K7	NC	-			PL16A	7	LDQ15	T
K8	NC	-			PL16B	7	LDQ15	C
E1	NC	-			PL17A	7	LDQ15	T (LVDS)*
F2	NC	-			PL17B	7	LDQ15	C (LVDS)*
F1	NC	-			PL18A	7	LDQ15	T
-	-	-			GNDIO7	-		
G3	NC	-			PL18B	7	LDQ15	C
H5	PL15A	7		T (LVDS)*	PL21A	7		T (LVDS)*
H4	PL15B	7		C (LVDS)*	PL21B	7		C (LVDS)*
J5	PL16A	7		T	PL22A	7		T
J4	PL16B	7		C	PL22B	7		C
GNDIO	GNDIO7	-			GNDIO7	-		
G2	NC	-			PL24A	7	LDQ28	T (LVDS)*
G1	NC	-			PL24B	7	LDQ28	C (LVDS)*
L9	NC	-			PL25A	7	LDQ28	T
L7	NC	-			PL25B	7	LDQ28	C
K6	NC	-			PL26A	7	LDQ28	T (LVDS)*
K5	NC	-			PL26B	7	LDQ28	C (LVDS)*
L8	NC	-			PL27A	7	LDQ28	T
L6	NC	-			PL27B	7	LDQ28	C
-	-	-			GNDIO7	-		
H3	PL18A	7		T (LVDS)*	PL28A	7	LDQS28	T (LVDS)*
H2	PL18B	7		C (LVDS)*	PL28B	7	LDQ28	C (LVDS)*
N8	PL19A	7		T	PL29A	7	LDQ28	T
M9	PL19B	7		C	PL29B	7	LDQ28	C
J3	PL20A	7		T (LVDS)*	PL30A	7	LDQ28	T (LVDS)*
VCCIO	VCCIO7	7			-	-		
J2	PL20B	7		C (LVDS)*	PL30B	7	LDQ28	C (LVDS)*
H1	PL21A	7		T	PL31A	7	LDQ28	T
GNDIO	GNDIO7	-			GNDIO7	-		
J1	PL21B	7		C	PL31B	7	LDQ28	C
-	-	-			-	-		
-	-	-			-	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L5	PL23A	7	LDQ27	T (LVDS)*	PL33A	7	LDQ37	T (LVDS)*
L4	PL23B	7	LDQ27	C (LVDS)*	PL33B	7	LDQ37	C (LVDS)*
N9	PL24A	7	LDQ27	T	PL34A	7	LDQ37	T
N7	PL24B	7	LDQ27	C	PL34B	7	LDQ37	C
K2	PL25A	7	LDQ27	T (LVDS)*	PL35A	7	LDQ37	T (LVDS)*
K1	PL25B	7	LDQ27	C (LVDS)*	PL35B	7	LDQ37	C (LVDS)*
P9	PL26A	7	LDQ27	T	PL36A	7	LDQ37	T
P7	PL26B	7	LDQ27	C	PL36B	7	LDQ37	C
GNDIO	GNDIO7	-			GNDIO7	-		
M6	PL27A	7	LDQS27	T (LVDS)*	PL37A	7	LDQS37	T (LVDS)*
M5	PL27B	7	LDQ27	C (LVDS)*	PL37B	7	LDQ37	C (LVDS)*
N5	PL28A	7	LDQ27	T	PL38A	7	LDQ37	T
N6	PL28B	7	LDQ27	C	PL38B	7	LDQ37	C
M4	PL29A	7	LDQ27	T (LVDS)*	PL39A	7	LDQ37	T (LVDS)*
M3	PL29B	7	LDQ27	C (LVDS)*	PL39B	7	LDQ37	C (LVDS)*
P6	PL30A	7	LDQ27	T	PL40A	7	LDQ37	T
GNDIO	GNDIO7	-			GNDIO7	-		
P8	PL30B	7	LDQ27	C	PL40B	7	LDQ37	C
L3	PL32A	7	LUM3_SPLLT_IN_A/LDQ36	T (LVDS)*	PL42A	7	LUM3_SPLLT_IN_A/LDQ46	T (LVDS)*
L2	PL32B	7	LUM3_SPLLC_IN_A/LDQ36	C (LVDS)*	PL42B	7	LUM3_SPLLC_IN_A/LDQ46	C (LVDS)*
P5	PL33A	7	LUM3_SPLLT_FB_A/LDQ36	T	PL43A	7	LUM3_SPLLT_FB_A/LDQ46	T
P4	PL33B	7	LUM3_SPLLC_FB_A/LDQ36	C	PL43B	7	LUM3_SPLLC_FB_A/LDQ46	C
L1	PL34A	7	LDQ36	T (LVDS)*	PL44A	7	LDQ46	T (LVDS)*
M2	PL34B	7	LDQ36	C (LVDS)*	PL44B	7	LDQ46	C (LVDS)*
R5	PL35A	7	LDQ36	T	PL45A	7	LDQ46	T
R4	PL35B	7	LDQ36	C	PL45B	7	LDQ46	C
GNDIO	GNDIO7	-			GNDIO7	-		
M1	PL36A	7	LDQS36	T (LVDS)*	PL46A	7	LDQS46	T (LVDS)*
N2	PL36B	7	LDQ36	C (LVDS)*	PL46B	7	LDQ46	C (LVDS)*
R8	PL37A	7	LDQ36	T	PL47A	7	LDQ46	T
T9	PL37B	7	LDQ36	C	PL47B	7	LDQ46	C
P3	PL38A	7	LDQ36	T (LVDS)*	PL48A	7	LDQ46	T (LVDS)*
P2	PL38B	7	LDQ36	C (LVDS)*	PL48B	7	LDQ46	C (LVDS)*
N1	PL39A	7	PCLKT7_0/LDQ36	T	PL49A	7	PCLKT7_0/LDQ46	T
GNDIO	GNDIO7	-			GNDIO7	-		
P1	PL39B	7	PCLKC7_0/LDQ36	C	PL49B	7	PCLKC7_0/LDQ46	C
T5	PL41A	6	PCLKT6_0	T (LVDS)*	PL51A	6	PCLKT6_0/LDQ55	T (LVDS)*
T4	PL41B	6	PCLKC6_0	C (LVDS)*	PL51B	6	PCLKC6_0/LDQ55	C (LVDS)*
U7	PL42A	6	VREF2_6	T	PL52A	6	VREF2_6/LDQ55	T
T8	PL42B	6	VREF1_6	C	PL52B	6	VREF1_6/LDQ55	C
R3	PL43A	6		T (LVDS)*	PL53A	6	LDQ55	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
R2	PL43B	6		C (LVDS)*	PL53B	6	LDQ55	C (LVDS)*
R1	PL44A	6		T	PL54A	6	LDQ55	T
T1	PL44B	6		C	PL54B	6	LDQ55	C
GNDIO	GNDIO6	-			GNDIO6	-		
-	-	-			VCCIO6	6		
T3	PL45A	6	LLM3_SPLLT_IN_A	T (LVDS)*	PL57A	6	LLM3_SPLLT_IN_A/LDQ55	T (LVDS)*

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
-	-	-			VCCIO2	2		
H23	NC	-			PR15B	2	RDQ15	C (LVDS)*
H24	NC	-			PR15A	2	RDQS15	T (LVDS)*
D28	NC	-			PR14B	2	RDQ15	C
-	-	-			GNDIO2	-		
E28	NC	-			PR14A	2	RDQ15	T
G24	PR13B	2		C (LVDS)*	PR13B	2	RDQ15	C (LVDS)*
H25	PR13A	2		T (LVDS)*	PR13A	2	RDQ15	T (LVDS)*
D27	PR12B	2	RUM0_SPLLC_FB_A	C	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C
GNDIO	GNDIO2	-			VCCIO2	2		
E27	PR12A	2	RUM0_SPLLT_FB_A	T	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T
F26	PR11B	2	RUM0_SPLLC_IN_A	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*
G25	PR11A	2	RUM0_SPLLT_IN_A	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*
F24	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
VCCIO	VCCIO2	-			-	-		
GNDIO	GNDIO2	-			GNDIO2	-		
F25	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2			VCCIO2	2		
G23	XRES	-			XRES	1		
C30	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
A29	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B30	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
B29	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
C27	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A26	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
A27	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
B26	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
C26	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
B25	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
C25	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A25	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
C29	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
B28	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
C28	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
A28	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
B24	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
E24	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D24	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
C24	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
A20	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T
C20	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
B20	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
C19	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A23	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
C23	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
B23	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
C22	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
B22	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO5	-			GNDIO5	-		
AE16	PB42B	5	BDQ42	C	PB51B	5	BDQ51	C
AF15	PB44A	5	BDQ42	T	PB53A	5	BDQ51	T
VCCIO	VCCIO5	5			VCCIO5	5		
AD16	PB44B	5	BDQ42	C	PB53B	5	BDQ51	C
AK17	PB45A	5	BDQ42	T	PB54A	5	BDQ51	T
AH16	PB45B	5	BDQ42	C	PB54B	5	BDQ51	C
AN16	PB46A	5	BDQ42	T	PB55A	5	BDQ51	T
GNDIO	GNDIO5	-			GNDIO5	-		
AP16	PB46B	5	BDQ42	C	PB55B	5	BDQ51	C
AL17	PB47A	5	BDQ51	T	PB56A	5	BDQ60	T
AM17	PB47B	5	BDQ51	C	PB56B	5	BDQ60	C
AN17	PB48A	5	BDQ51	T	PB57A	5	BDQ60	T
AP17	PB48B	5	BDQ51	C	PB57B	5	BDQ60	C
AD17	PB49A	5	BDQ51	T	PB58A	5	BDQ60	T
AE17	PB49B	5	BDQ51	C	PB58B	5	BDQ60	C
VCCIO	VCCIO5	5			VCCIO5	5		
AL18	PB50A	5	BDQ51	T	PB59A	5	BDQ60	T
AM18	PB50B	5	BDQ51	C	PB59B	5	BDQ60	C
GNDIO	GNDIO5	-			GNDIO5	-		
AP18	PB51A	5	BDQS51	T	PB60A	5	BDQS60	T
AN18	PB51B	5	BDQ51	C	PB60B	5	BDQ60	C
AG17	PB52A	5	VREF2_5/BDQ51	T	PB61A	5	VREF2_5/BDQ60	T
AJ17	PB52B	5	VREF1_5/BDQ51	C	PB61B	5	VREF1_5/BDQ60	C
AF17	PB53A	5	PCLKT5_0/BDQ51	T	PB62A	5	PCLKT5_0/BDQ60	T
AH17	PB53B	5	PCLKC5_0/BDQ51	C	PB62B	5	PCLKC5_0/BDQ60	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
AF18	PB58A	4	PCLKT4_0/BDQ60	T	PB67A	4	PCLKT4_0/BDQ69	T
VCCIO	VCCIO4	4			VCCIO4	4		
AD18	PB58B	4	PCLKC4_0/BDQ60	C	PB67B	4	PCLKC4_0/BDQ69	C
AP19	PB59A	4	VREF2_4/BDQ60	T	PB68A	4	VREF2_4/BDQ69	T
AN19	PB59B	4	VREF1_4/BDQ60	C	PB68B	4	VREF1_4/BDQ69	C
AP20	PB60A	4	BDQS60	T	PB69A	4	BDQS69	T
GNDIO	GNDIO4	-			GNDIO4	-		
AM20	PB60B	4	BDQ60	C	PB69B	4	BDQ69	C
AN20	PB61A	4	BDQ60	T	PB70A	4	BDQ69	T
AM21	PB61B	4	BDQ60	C	PB70B	4	BDQ69	C
AG18	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T
VCCIO	VCCIO4	4			VCCIO4	4		
AE18	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C
AJ18	PB63A	4	BDQ60	T	PB72A	4	BDQ69	T
AH18	PB63B	4	BDQ60	C	PB72B	4	BDQ69	C
AK18	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T
GNDIO	GNDIO4	-			GNDIO4	-		
AK19	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C
AP21	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T
AN21	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C
AL20	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K11	NC	-			NC	-		
K12	NC	-			NC	-		
K13	NC	-			NC	-		
K23	NC	-			NC	-		
K24	NC	-			NC	-		
K25	NC	-			NC	-		
K26	NC	-			NC	-		
L11	NC	-			NC	-		
L12	NC	-			NC	-		
L13	NC	-			NC	-		
L14	NC	-			NC	-		
L21	NC	-			NC	-		
L22	NC	-			NC	-		
L23	NC	-			NC	-		
L24	NC	-			NC	-		
L25	NC	-			NC	-		
L26	NC	-			NC	-		
M11	NC	-			NC	-		
M24	NC	-			NC	-		
M25	NC	-			NC	-		
M6	NC	-			NC	-		
M8	NC	-			NC	-		
N10	NC	-			NC	-		
N11	NC	-			NC	-		
P10	NC	-			NC	-		
P25	NC	-			NC	-		
P26	NC	-			NC	-		
R9	NC	-			NC	-		
T11	NC	-			NC	-		
U11	NC	-			NC	-		
W11	NC	-			NC	-		
Y10	NC	-			NC	-		
Y11	NC	-			NC	-		
R15	VCCPLL	-			VCCPLL	-		
R20	VCCPLL	-			VCCPLL	-		
Y15	VCCPLL	-			VCCPLL	-		
Y20	VCCPLL	-			VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70, and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20SE-5F484I	304	1.2V	-5	fpBGA	484	Ind	20
LFE2M20SE-6F484I	304	1.2V	-6	fpBGA	484	Ind	20
LFE2M20SE-5F256I	140	1.2V	-5	fpBGA	256	Ind	20
LFE2M20SE-6F256I	140	1.2V	-6	fpBGA	256	Ind	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35SE-5F672I	410	1.2V	-5	fpBGA	672	Ind	35
LFE2M35SE-6F672I	410	1.2V	-6	fpBGA	672	Ind	35
LFE2M35SE-5F484I	303	1.2V	-5	fpBGA	484	Ind	35
LFE2M35SE-6F484I	303	1.2V	-6	fpBGA	484	Ind	35
LFE2M35SE-5F256I	140	1.2V	-5	fpBGA	256	Ind	35
LFE2M35SE-6F256I	140	1.2V	-6	fpBGA	256	Ind	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50SE-5F900I	410	1.2V	-5	fpBGA	900	Ind	50
LFE2M50SE-6F900I	410	1.2V	-6	fpBGA	900	Ind	50
LFE2M50SE-5F672I	372	1.2V	-5	fpBGA	672	Ind	50
LFE2M50SE-6F672I	372	1.2V	-6	fpBGA	672	Ind	50
LFE2M50SE-5F484I	270	1.2V	-5	fpBGA	484	Ind	50
LFE2M50SE-6F484I	270	1.2V	-6	fpBGA	484	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70SE-5F1152I	436	1.2V	-5	fpBGA	1152	Ind	70
LFE2M70SE-6F1152I	436	1.2V	-6	fpBGA	1152	Ind	70
LFE2M70SE-5F900I	416	1.2V	-5	fpBGA	900	Ind	70
LFE2M70SE-6F900I	416	1.2V	-6	fpBGA	900	Ind	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5F1152I	520	1.2V	-5	fpBGA	1152	Ind	100
LFE2M100SE-6F1152I	520	1.2V	-6	fpBGA	1152	Ind	100
LFE2M100SE-5F900I	416	1.2V	-5	fpBGA	900	Ind	100
LFE2M100SE-6F900I	416	1.2V	-6	fpBGA	900	Ind	100